

MOSFET

OptiMOS[™] 6 Power-Transistor, 40 V

Features

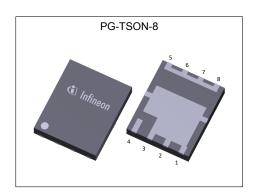
- N-channel, normal level
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Rey 1 differmation 1 diameters								
Parameter	Value	Unit						
$V_{ extsf{DS}}$	40	V						
R _{DS(on),max}	0.47	mΩ						
I _D	610	A						
Qoss	142	nC						
Q _G	130	nC						











Type / Ordering Code	Package	Marking	Related Links
IQD005N04NM6	PG-TSON-8	00504N6	-

OptiMOS[™] 6 Power-Transistor, 40 V



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OptiMOS[™] 6 Power-Transistor, 40 V IQD005N04NM6



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Oh a l	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	610 431 402 58	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =6 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	2440	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	1115	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	333 3.0	W	T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
rarameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.45	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area ²⁾	R _{thJA}	-	-	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for source

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Static characteristics Table 4

Parameter	0		Values	5	1114	
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	40	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.8	2.3	2.8	V	V _{DS} =V _{GS} , I _D =1449 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =40 V, V _{GS} =0 V, T _j =25 °C V _{DS} =40 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.42 0.48	0.47 0.54	mΩ	V _{GS} =10 V, I _D =50 A V _{GS} =6 V, I _D =50 A
Gate resistance	R _G	-	0.7	-	Ω	-
Transconductance	g fs	185	370	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 50 A$

Table 5 **Dynamic characteristics**

Devementar	Cymahal	Values			11	Nata / Tant Candition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	C _{iss}	-	9000	12000	pF	V _{GS} =0 V, V _{DS} =20 V, <i>f</i> =1 MHz	
Output capacitance ¹⁾	Coss	-	2900	3800	pF	V _{GS} =0 V, V _{DS} =20 V, f=1 MHz	
Reverse transfer capacitance ¹⁾	C _{rss}	-	69	120	pF	V _{GS} =0 V, V _{DS} =20 V, <i>f</i> =1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	15	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	6	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{\sf d(off)}$	-	42	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	9	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω	

Table 6 Gate charge characteristics²⁾

Parameter	O. mak al		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	30	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	21	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	18	26	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	27	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	130	163	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	3.3	-	V	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	122	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Q _{oss}	-	142	189	nC	V _{DS} =20 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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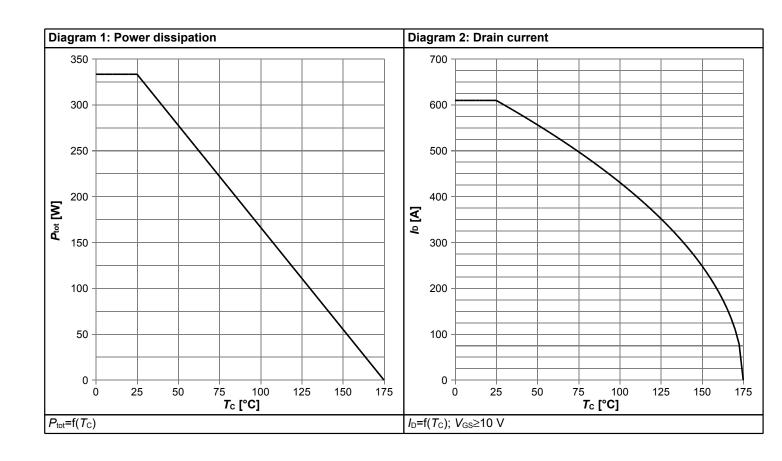


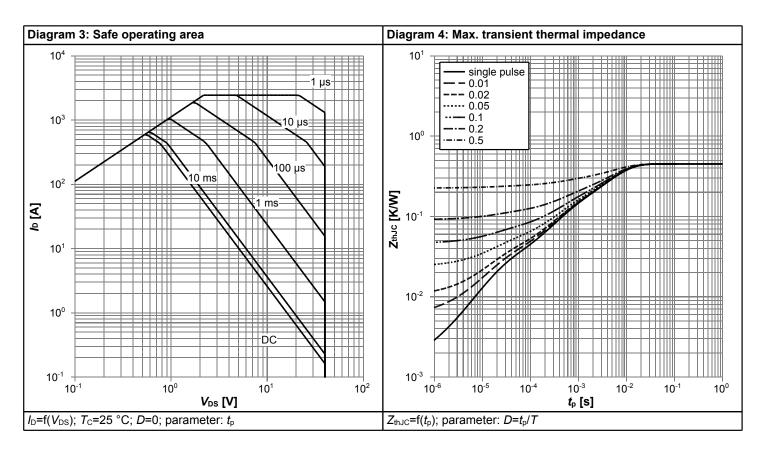
Table 7 Reverse diode

Parameter	Cumbal		Values			Nata / Tank Canadition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	290	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	2440	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.78	1.0	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	58	116	ns	V _R =20 V, I _F =25 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	79	158	nC	V _R =20 V, I _F =25 A, di _F /dt=100 A/μs
Reverse recovery time ¹⁾	t _{rr}	-	29	58	ns	V _R =20 V, I _F =50 A, di _F /dt=1000 A/μs
Reverse recovery charge ¹⁾	Qrr	-	221	442	nC	V_R =20 V, I_F =50 A, di_F/dt =1000 A/ μ s

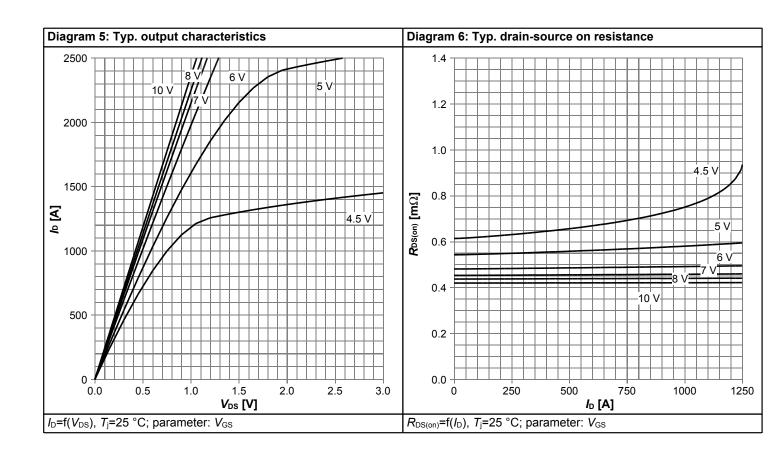


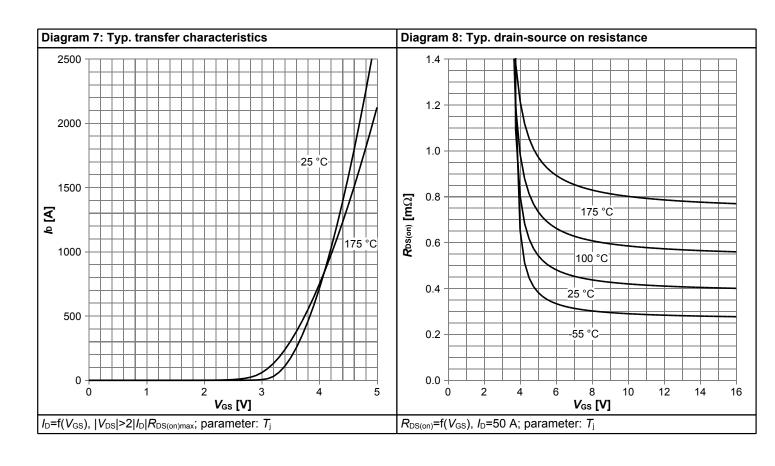
4 Electrical characteristics diagrams



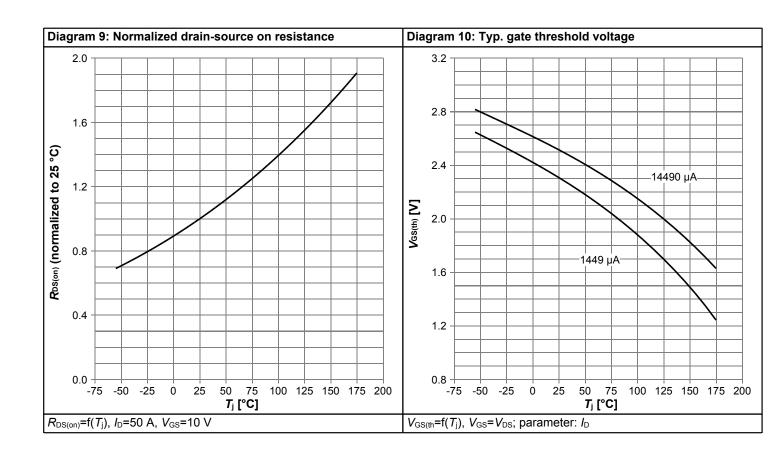


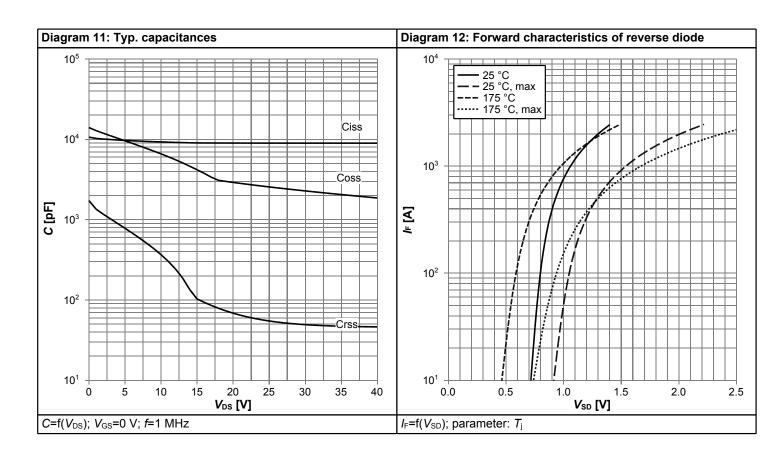




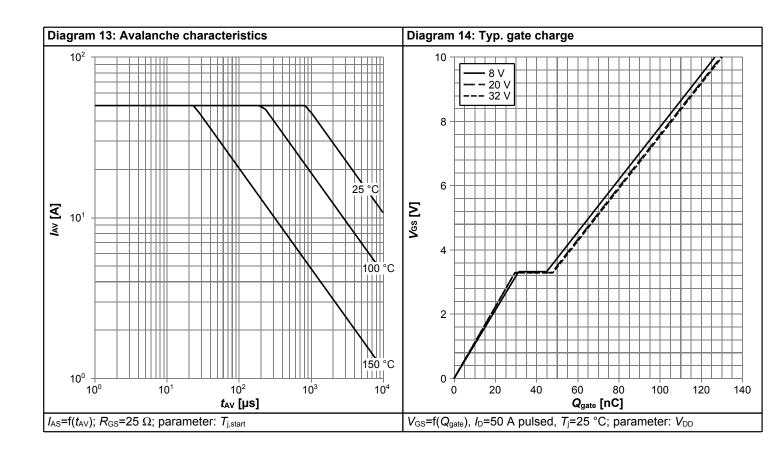


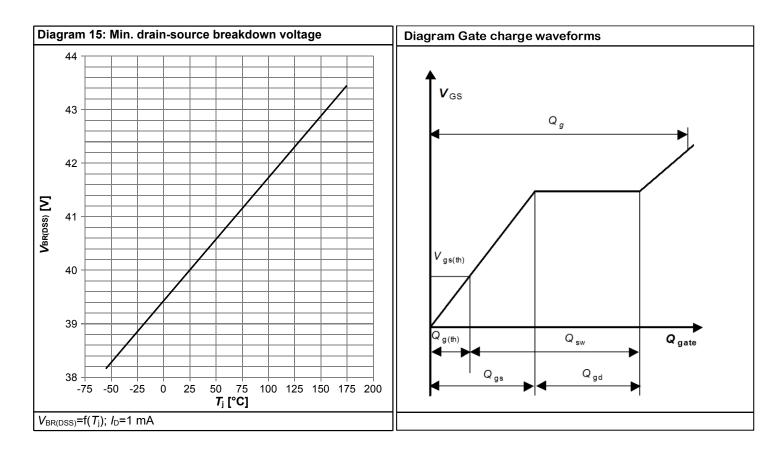














5 Package Outlines

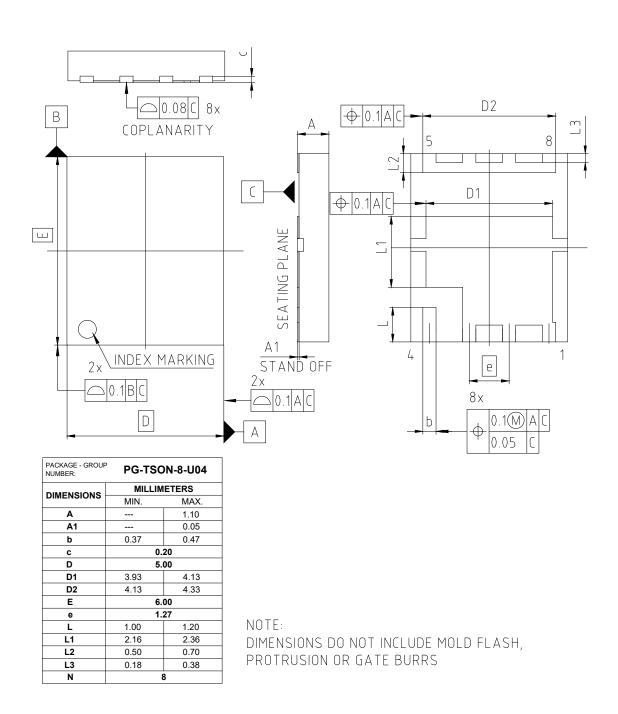


Figure 1 Outline PG-TSON-8, dimensions in mm

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Revision History

IQD005N04NM6

Revision: 2023-08-08, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2023-08-08	Release of final version

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